

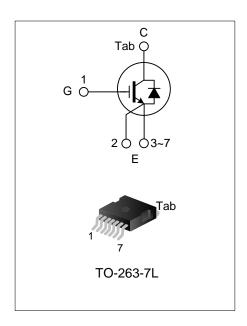
40A, 650V FIELD STOP IGBT

DESCRIPTION

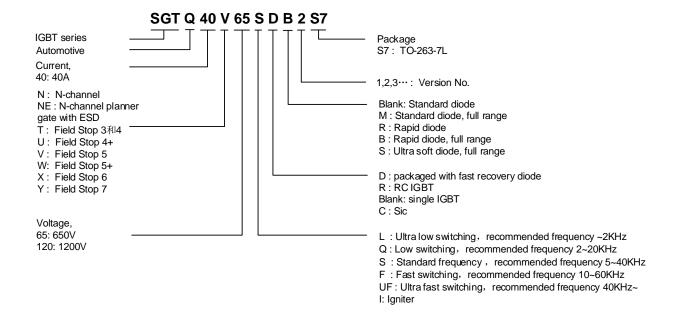
The SGTQ40V65SDB2S7 field stop IGBT adopts Silan Field Stop 5 technology. It features low conduction loss and switching loss, is applicable to photovoltaic, UPS, SMPS and PFC fields.

FEATURES

- 40A, 650V, V_{CE(sat)(typ.)}=1.35V@I_C=40A
- Low conduction loss
- Fast switching
- High input impedance
- $T_{Jmax}=175^{\circ}C$



NOMENCLATURE



ORDERING INFORMATION

Part No.	Package	Marking	Hazardous Substance Control	Packing Type
SGTQ40V65SDB2S7	TO-263-7L	Q40V65SDB2	Halogen free	Tube
SGTQ40V65SDB2S7TR	TO-263-7L	Q40V65SDB2	Halogen free	Tape & Reel

HANGZHOU SILAN MICROELECTRONICS CO.,LTD



ABSOLUTE MAXIMUM RATINGS (T_C=25°C, UNLESS OTHERWISE NOTED)

Charac	teristics	Symbol	Ratings	Unit
Collector-emitter \	/oltage	V _{CE}	650	V
Gate-emitter Volta	ge	V_{GE}	±20	V
Transient Gate-em (t _p ≤10µs, D<0.010	•	V_{GE}	±30	V
Collector Current	T _C =25°C		80	Α
Collector Current	T _C =100°C	- I _C	40	A
Pulsed Collector Current		I _{CM}	160	Α
Diode Forward	T _C =25°C		80	Α
Current	T _C =100°C	l _F	40	A
Diode Pulse Curre	nt	I _{FM}	160	Α
Power Dissipation	(T _C =25°C)	P _D	167	W
Operating Junction	n Temperature	TJ	-40∼+175	°C
Storage Temperati	ure Range	T _{stg}	-55∼+150	°C

THERMAL CHARACTERISTICS

Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Thermal Resistance, Junction to Case	R _{eJC}				0.9	°C/W
(IGBT)	KejC				0.9	C/VV
Thermal Resistance, Junction to Case	R _{eJC}				1.0	°C/W
(FRD)	Kejc				1.0	C/VV
Thermal Resistance, Junction to	$R_{ hetaJA}$				40	°C/W
Ambient (IGBT)	Көја				40	C/VV
Soldering Temperature (SMD)	т	Reflow soldering: 10±1			260	00
Soldering Temperature (SMD)	T _{sold}	sec, 3times			260	°C



ELECTRICAL CHARACTERISTICS OF IGBT (T_C=25°C, UNLESS OTHERWISE NOTED)

Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Collector-emitter Breakdown	D) /	V 0V I 050A	CEO			V
Voltage	BV_CE	$V_{GE}=0V, I_{C}=250\mu A$	650			V
Zero Gate Voltage Collector	I _{CES}	V _{CE} =650V, V _{GE} =0V			40	пΛ
Current	ICES	VCE-000 V, VGE-0 V			40	μA
Gate-emitter Leakage Current	I_{GES}	V _{GE} =20V, V _{CE} =0V			±100	nA
Gate-emitter Threshold Voltage	$V_{\text{GE(th)}}$	I _C =250uA, V _{CE} =V _{GE}	3.0	4.2	5.4	V
Collector-emitter Saturation		I _C =40A, V _{GE} =15V, T _C =25°C		1.35	2.0	V
Voltage	$V_{\text{CE(sat)}}$	$I_C=40A$, $V_{GE}=15V$,		1.58		V
		T _C =175°C		1.00		V
Input Capacitance	C _{ies}	V _{CE} =30V		2870		
Output Capacitance	Coes	V _{GE} =0V		91		pF
Reverse Transfer Capacitance	C_{res}	f=1MHz		10		
Turn-on Delay Time	$T_{d(on)}$	1/ 4001/		28		ns
Rise Time	Tr	V_{CE} =400V I_{C} =40A R_{g} =10 Ω V_{GE} =15V		19		
Turn-off Delay Time	$T_{d(off)}$			129		
Fall Time	T_f			17		
Turn-on Energy	Eon	Inductive load		1.18		
Turn-off Energy	E_{off}	- T _C =25°C		0.88		mJ
Total Switching Energy	E_{st}			2.06		
Turn-on Delay Time	$T_{d(on)}$	1/ 400)/		26		
Rise Time	Tr	V _{CE} =400V		7.2		20
Turn-off Delay Time	$T_{d(off)}$	I _C =20A		149		ns
Fall Time	T_f	$R_g=10\Omega$ $V_{GE}=15V$ Inductive load $T_C=25^{\circ}C$		13		
Turn-on Energy	Eon			0.56		
Turn-off Energy	E _{off}			0.34		mJ
Total Switching Energy	E _{st}			0.90		
Total Gate Charge	Q_g	\/ 520\/ 1 40.4		105		
Gate to Emitter Charge	Q _{ge}	$V_{CE}=520V$, $I_{C}=40A$,		22		nC
Gate to Collector Charge	Q _{gc}	V _{GE} =15V		27		

ELECTRICAL CHARACTERISTICS OF FRD (T_C=25°C, UNLESS OTHERWISE NOTED)

Parameter	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Diode Forward Voltage	V_{FM}	I _F =40A, T _C =25°C		1.0	1.35	V
		I _F =40A, T _C =175°C		0.92	-	
Diode Reverse Recovery Time	Trr			323		ns
Diode Reverse Recovery Charge	Q_{rr}	I _{ES} =40A, dI _{ES} /dt=200A/μs,		2.9		μC
Diode Peak Reverse Recovery	Irm	V _R =50V, T _C =25°C		19		А
Current				19		A



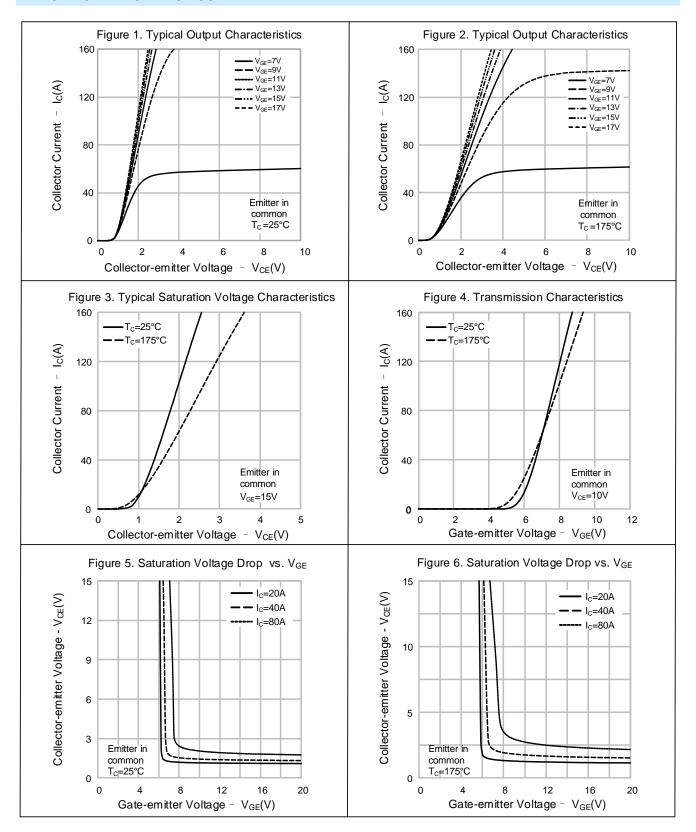
ELECTRICAL CHARACTERISTICS OF IGBT (T_C=175°C)

Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Turn-on Delay Time	T _{d(on)}	V 400V		28		
Rise Time	Tr	V _{CE} =400V		20		20
Turn-off Delay Time	$T_{d(off)}$	I _C =40A	1	170	1	ns
Fall Time	T _f	$R_g=10\Omega$		24		
Turn-on Energy	E _{on}	V _{GE} =15V Inductive load T _C =175°C	1	1.31	1	
Turn-off Energy	E _{off}		1	1.09	1	mJ
Total Switching Energy	E _{st}			2.40		
Turn-on Delay Time	T _{d(on)}	$V_{CE}=400V$ $I_{C}=20A$ $R_{g}=10\Omega$ $V_{GE}=15V$ $Inductive load$ $T_{C}=175^{\circ}C$		27		
Rise Time	Tr			8.4		ne
Turn-off Delay Time	T _{d(off)}			188		ns
Fall Time	T _f			26		
Turn-on Energy	Eon			0.60		
Turn-off Energy	E _{off}			0.50		mJ
Total Switching Energy	E _{st}	10-110		1.10		

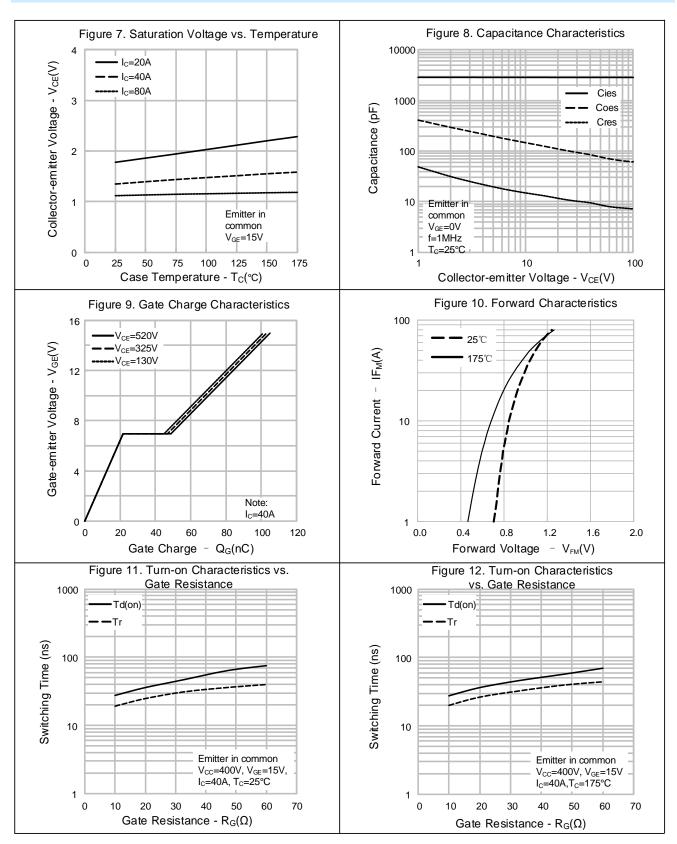
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TYPICAL CHARACTERISTICS

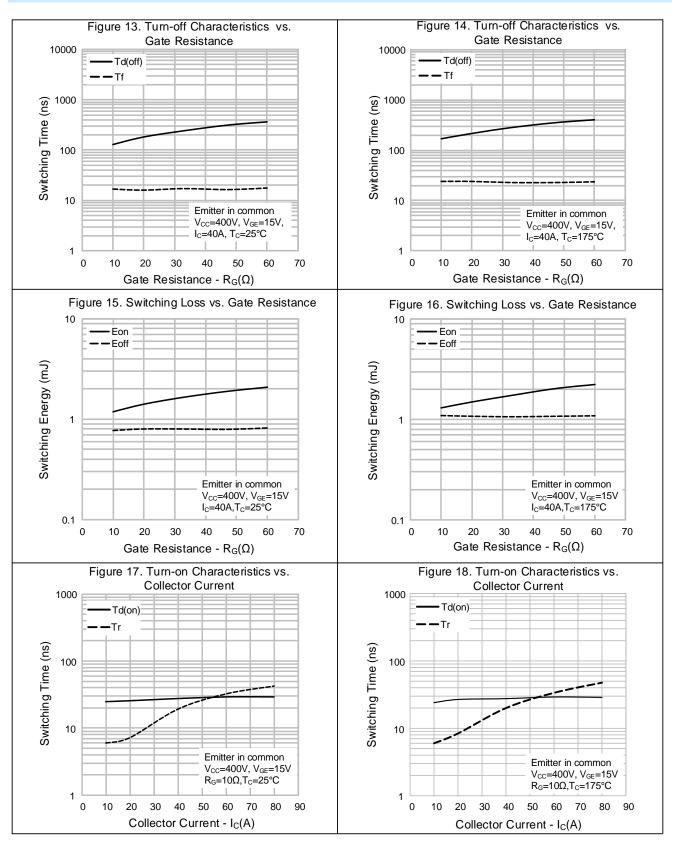






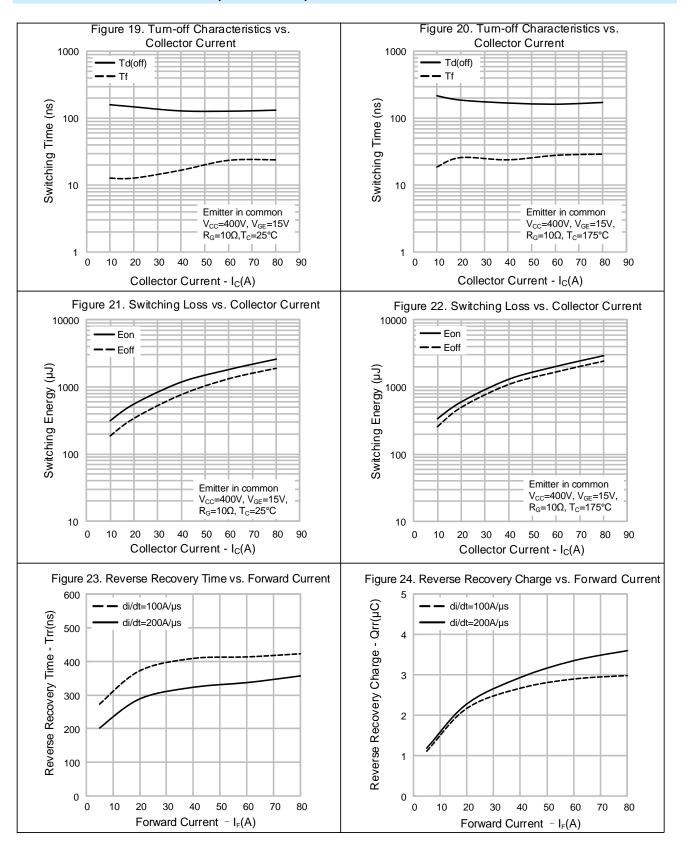
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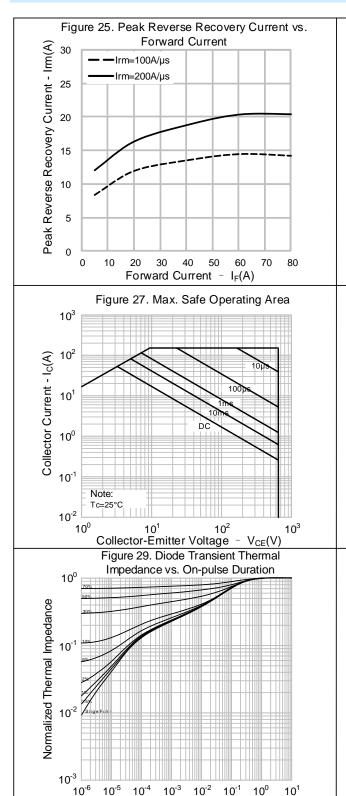
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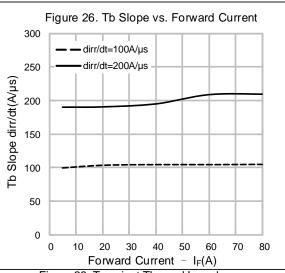


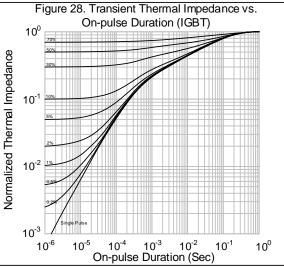


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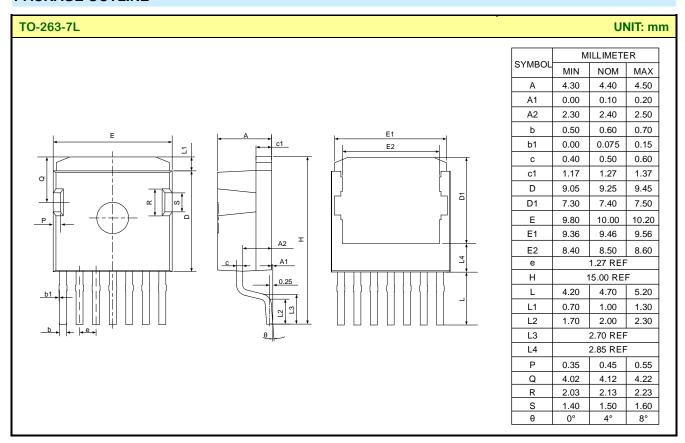


On-pulse Duration (Sec)

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PACKAGE OUTLINE





IGBT DEVICES OPERATE NOTES:

Electrostatic charges may exist in many things. Please take following preventive measures to prevent effectively the IGBT electric circuit as a result of the damage which is caused by discharge:

- The operator must put on wrist strap which should be earthed to against electrostatic.
- Equipment cases should be earthed.
- All tools used during assembly, including soldering tools and solder baths, must be earthed.
- IGBT devices should be packed in antistatic/conductive containers for transportation.



Important notice:

- 1. Silan reserves the right to make changes of this instruction without notice.
- Customers should obtain the latest relevant information when purchasing and should verify whether such information is latest and complete. Please read this instruction and application manual and related materials carefully before using products, including the circuit operation precautions, etc.
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- Product promotion is endless, our company will wholeheartedly provide customers with better products! 8.
- 9. Website: http://www.silan.com.cn



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1.0 Rev.: Revision History:

First release

Rev.:1.0